

August 1986 Revised January 2000

DM74LS243 Quadruple Bus Transceiver

General Description

This four data line transceiver is designed for asynchronous two-way communications between data buses. It can be used to drive terminated lines down to 133 Ω .

Features

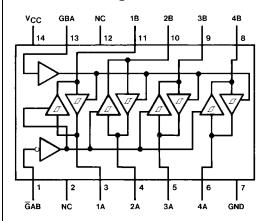
- Two-way asynchronous communication between data buses
- PNP inputs reduce DC loading on bus line
- Hysteresis at data inputs improves noise margin

Ordering Code:

Order Number	Package Number	Package Description			
DM74LS243M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow			
DM74LS243N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide			

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Function Table

I	Cor	ntrol	Data Port		
	Inp	uts	Status		
	G AB	GBA	Α	В	
	Н	Н	0	1	
	L	Н	(Note 1)	(Note 1)	
	Н	L	ISOL	ATED	
	L	L	1	0	

I = Input
O = Output
H = HIGH Logic Level

L = LOW Logic Level

Note 1: Possibly destructive oscillation may occur if the transceivers are

Absolute Maximum Ratings(Note 2)

 Supply Voltage
 7V

 Input Voltage
 7V

 Any G
 7V

 A or B
 5.5V

Operating Free Air Temperature Range 0°C to $+70^{\circ}\text{C}$ Storage Temperature Range -65°C to $+150^{\circ}\text{C}$

Note 2: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	Min	Nom	Max	Units
V _{CC}	Supply Voltage	4.75	5	5.25	V
V _{IH}	HIGH Level Input Voltage	2			V
V _{IL}	LOW Level Input Voltage			0.8	V
I _{ОН}	HIGH Level Output Current			-15	mA
I _{OL}	LOW Level Output Current			24	mA
T _A	Free Air Operating Temperature	0		70	°C

Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

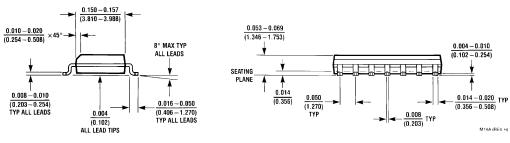
Symbol	Parameter	Conditions		Min	Typ (Note 3)	Max	Units	
VI	Input Clamp Voltage	$V_{CC} = Min, I_I =$	$V_{CC} = Min, I_I = -18 \text{ mA}$				-1.5	V
HYS	Hysteresis (V _{T+} – V _{T-})	V _{CC} = Min			0.2	0.4		V
	(Data Inputs Only)							
V _{OH}	HIGH Level Output Voltage	$V_{CC} = Min, V_I$	V _{CC} = Min, V _{IH} = Min					
		$V_{IL} = Max, I_{OH}$	$V_{IL} = Max$, $I_{OH} = -1$ mA					
		$V_{CC} = Min, V_I$	_H = Min		2.4	3.4		V
		V _{IL} = Max, I _{OI}	$_{H} = -3 \text{ mA}$					
		$V_{CC} = Min, V_I$	_H = Min		2			†
		$V_{IL} = 0.5V$, I_{OI}	$V_{IL} = 0.5V$, $I_{OH} = Max$					
V _{OL}	LOW Level Output Voltage	$V_{CC} = Min$	I _{OL} = 12 mA				0.4	
		$V_{IL} = Max$	I _{OL} = Max					V
		$V_{IH} = Min$					0.5	
I _{OZH}	Off-State Output Current,	V _{CC} = Max	$V_0 = 2.7V$				40	μΑ
	HIGH Level Voltage Applied	$V_{IL} = Max$						
I _{OZL}	Off-State Output Current,	V _{IH} = Min	$V_0 = 0.4V$				-200	μΑ
	LOW Level Voltage Applied							
II	Input Current at Maximum	V _{CC} = Max	V _I = 5.5V	A or B			0.1	mA
	Input Voltage		$V_I = 7V$	Any G			0.1	mA
I _{IH}	HIGH Level Input Current	V _{CC} = Max, V	$V_{CC} = Max, V_I = 2.7V$				20	μΑ
I _{IL}	LOW Level Input Current	$V_{CC} = Max, V_I = 0.4V$					-0.2	mA
Ios	Short Circuit Output Current	V _{CC} = Max (N	V _{CC} = Max (Note 4)		-40		-225	mA
I _{CC}	Supply Current	V _{CC} = Max	V _{CC} = Max Outputs HIGH			22	38	
		Outputs	Outputs LOW			29	50	mA
		OPEN	Outputs Disa	bled		32	54	Ī

Note 3: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 4: Not more than one output should be shorted at a time, and the duration should not exceed one second.

Switching Characteristics $_{\rm at\ V_{CC}=5V,\ T_A=25^{\circ}C}$

Symbol	Parameter	Conditions	Min	Max	Units
t _{PLH}	Propagation Delay Time	C _L = 45 pF		18	ns
	LOW-to-HIGH Level Output	$R_L = 667\Omega$		10	115
t _{PHL}	Propagation Delay Time	C _L = 45 pF		18	ns
	HIGH-to-LOW Level Output	$R_L = 667\Omega$		10	
t _{PZL}	Output Enable Time	C _L = 45 pF		30	ns
	to LOW Level	$R_L = 667\Omega$		30	115
t _{PZH}	Output Enable Time	C _L = 45 pF		23	ns
	to HIGH Level	$R_L = 667\Omega$		23	115
t _{PLZ}	Output Disable Time	C _L = 5 pF		25	ns
	from LOW Level	$R_L = 667\Omega$		23	
t _{PHZ}	Output Disable Time	C _L = 5 pF		18	ns
	from HIGH Level	$R_L = 667\Omega$		10	
t _{PLH}	Propagation Delay Time	C _L = 150 pF		21	ns
	LOW-to-HIGH Level Output	$R_L = 667\Omega$		2.1	
t _{PHL}	Propagation Delay Time	C _L = 150 pF		22	ns
	HIGH-to-LOW Level Output	$R_L = 667\Omega$		22	
t _{PZL}	Output Enable Time	C _L = 150 pF		33	ns
	to LOW Level	$R_L = 667\Omega$		33	115
t _{PZH}	Output Enable Time	C _L = 150 pF		26	ns
	to HIGH Level	$R_L = 667\Omega$		20	



14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow Package Number M14A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 0.740 - 0.770(18.80 - 19.56)0.090 (2.286) 14 13 12 11 10 9 8 14 13 12 0.250 ± 0.010 PIN NO. 1 IDENT PIN NO. 1 IDENT 1 2 3 4 5 6 7 1 2 3 $\frac{0.092}{(2.337)}$ DIA 0.030 MAX (0.762) DEPTH OPTION 1 OPTION 02 $\frac{0.135 \pm 0.005}{(3.429 \pm 0.127)}$ 0.300 - 0.320 $\overline{(7.620 - 8.128)}$ 0.065 $\frac{0.145 - 0.200}{(3.683 - 5.080)}$ 0.060 4° TYP Optional (1.524) (1.651) $\frac{0.008 - 0.016}{(0.203 - 0.406)}$ TYP 0.020 (0.508) 0.125 - 0.150 0.075 ± 0.015 (3.175 - 3.810)0.280 (1.905 ± 0.381) 0.014-0.023 TYP (7.112) MIN

14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N14A

 $\frac{0.050 \pm 0.010}{(1.270 - 0.254)}$ TYP

0.100 ± 0.010 (2.540 ± 0.254)

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(0.356 - 0.584)

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0.325 ^{+0.040} -0.015 $8.255 + 1.016 \\ -0.381$

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N144 (REV.E)